ASSOCIATION CONNECT ELECTRONICS INDUSTR	Material Composit © Copyright 2005. IPC, international and Pan-Ar	Bannockb	urn, Illinois. A	ll rights reserved un ntions.	nder both	This docume level parts, t	ent is a declarat	ion of the spencompasse	ubstances s all lower	within the manufactur r level materials for w	er listed i hich the n	tem. Note: it nanufacturer	f the item is an as has engineering	sembly with lower responsibility.
1752-21.1					Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information			
Supplier Inform	mation													
Company name*			Company unique ID				Unique ID Authority				Response Date*			
onsemi										2025-06-06				
Contact Name		Title - Contact				Phone - Contact*				Email - Contact*				
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Authorized Repres	sentative*	Title - Representative				Phone - Representative*			Email - Representative*					
Product-Env-Stev	vards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Reques	Requester Item Number Mfr Iten		n Number Mfr Item Name				Effective Date	Version	N	Manufacturing Site	,	Weight*	UOM	Unit Type
		NCV8664CST33T3G		3.3V, 150MA LDO			2025-06-06 MY1		-	105.98	mg	Each		
Manufacturing	g Proccess Information	1						-						
Terminal Plating / Grid Array Material Term			rminal Base Alloy J-STD-020 MSL F		L Rating	Peak Process Body Temperature Max		e Max Time at Peak	Temperat	ure Numb	er of Reflow Cyc	eles		
Matte Tin (Sn) - annealed CU			U Alloy 3			260 C		С	30	secon	ds 3			
Comments														
TTENTION: MS	SL 3 Rated item requires Ba	ke and D	ry Pack (after	electrical test)										
or more information	tion regarding material con	position p	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl shthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.26	mg	Supplier	Silicon (Si)	7440-21-3		1.26	mg
Die Attach	0.32	mg	Supplier	Silver (Ag)	7440-22-4		0.24	mg
			Supplier	Epoxy resins	129915-35-1		0.08	mg
Lead Frame	37.17	mg	Supplier	Silver (Ag)	7440-22-4		0.4832	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0372	mg
			Supplier	Iron (Fe)	7439-89-6		0.8921	mg
			Supplier	Copper (Cu)	7440-50-8		35.7575	mg
Mold Compound-Black	59.7	mg		Epoxy Phenol Resin	proprietary data		5.373	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2985	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		52.2076	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.8209	mg
Plating	7.44	mg	Supplier	Tin (Sn)	7440-31-5		7.44	mg
Wire Bond - Au	0.09	mg	Supplier	Gold (Au)	7440-57-5		0.09	mg